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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET

PEMD4; PUMD4 NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

Product data sheet Supersedes data of 2002 Jan 14 2003 Oct 10



NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

PEMD4; PUMD4

FEATURES

- Built-in bias resistors
- Simplified circuit design
- · Reduction of component count
- · Reduced pick and place costs.

APPLICATIONS

- · Low current peripheral driver
- Replacement for general purpose transistors in digital applications
- . Control of IC inputs.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V_{CEO}	collector-emitter voltage	_	50	V
I _O	output current (DC)	ı	100	mA
TR1	NPN	_	_	_
TR2	PNP	ı	ı	ı
R1	bias resistor	10		kΩ
R2	open	_	_	_

DESCRIPTION

NPN/PNP resistor-equipped transistors (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE	PAC	KAGE	MARKING CODE	PNP/PNP	NPN/NPN	
NUMBER	PHILIPS	EIAJ	WARKING CODE	COMPLEMENT	COMPLEMENT	
PEMD4	SOT666		23	PEMB4	PEMH4	
PUMD4	SOT363	SC-88	D*4	PUMB4	PUMH4	

Note

- * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL		PINNING
TIPE NOWIBER	SIMIFLIFIED OUTLINE AND STMBOL	PIN	DESCRIPTION
PEMD4 PUMD4	6 5 4 6 5 4	1 2	emitter TR1 base TR1
i omb i	R1	3	collector TR2
	TR1 TR2	4 5	emitter TR2 base TR2
		6	collector TR1
	Top view MDB814		

NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

PEMD4; PUMD4

ORDERING INFORMATION

TYPE NUMBER		PACKAGE	
TIPE NUMBER	NAME	DESCRIPTION	VERSION
PEMD4	_	plastic surface mounted package; 6 leads	SOT666
PUMD4	_	plastic surface mounted package; 6 leads	SOT363

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transist	or; for the PNP transistor with ne	gative polarity			
V _{CBO}	collector-base voltage	open emitter	_	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
Io	output current (DC)		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT363	note 1	_	200	mW
	SOT666	notes 1 and 2	_	200	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C
Per device					
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT363	note 1	_	300	mW
	SOT666	notes 1 and 2	_	300	mW

Notes

- 1. Device mounted on an FR4 printed-circuit board, single-sided copper, standard footprint.
- 2. Reflow soldering is the only recommended soldering method.

NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

PEMD4; PUMD4

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per transis	stor			
R _{th j-a}	thermal resistance from junction to ambient	T _{amb} ≤ 25 °C		
	SOT363	note 1	625	K/W
	SOT666	notes 1 and 2	625	K/W
Per device				
R _{th j-a}	thermal resistance from junction to ambient	T _{amb} ≤ 25 °C		
	SOT363	note 1	416	K/W
	SOT666	notes 1 and 2	416	K/W

Notes

- 1. Device mounted on an FR4 printed-circuit board, single-sided copper, standard footprint.
- 2. Reflow soldering is the only recommended soldering method.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT	
Per transis	stor; for the PNP transistor with ne	gative polarity	•	•	•	•
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	-	-	1	μΑ
		$V_{CE} = 30 \text{ V}; I_{B} = 0; T_{j} = 150 ^{\circ}\text{C}$	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$	200	_	-	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	150	mV
R1	input resistor		7	10	13	kΩ
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$				
	TR1 (NPN)		_	_	2.5	pF
	TR2 (PNP)		_	_	3	pF

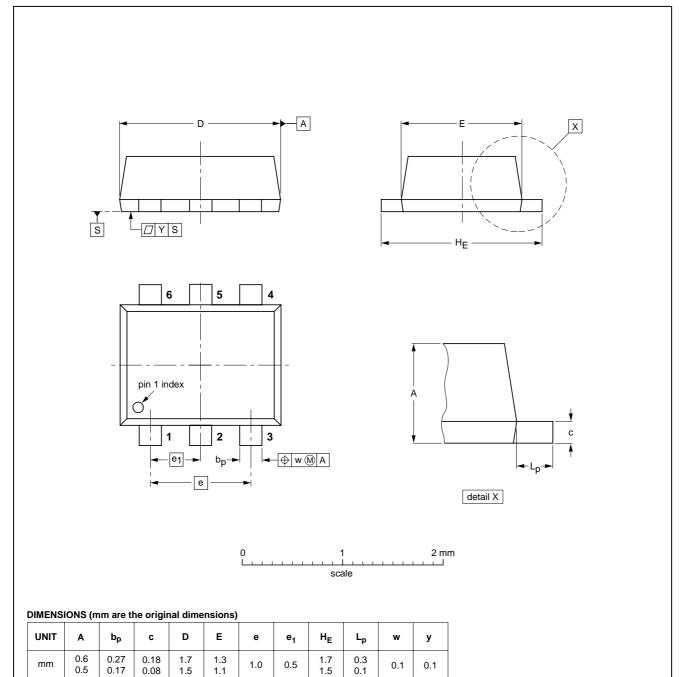
NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

PEMD4; PUMD4

PACKAGE OUTLINES

Plastic surface mounted package; 6 leads

SOT666



OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJEC		ISSUE DATE
SOT666						01-01-04 01-08-27

2003 Oct 10 5

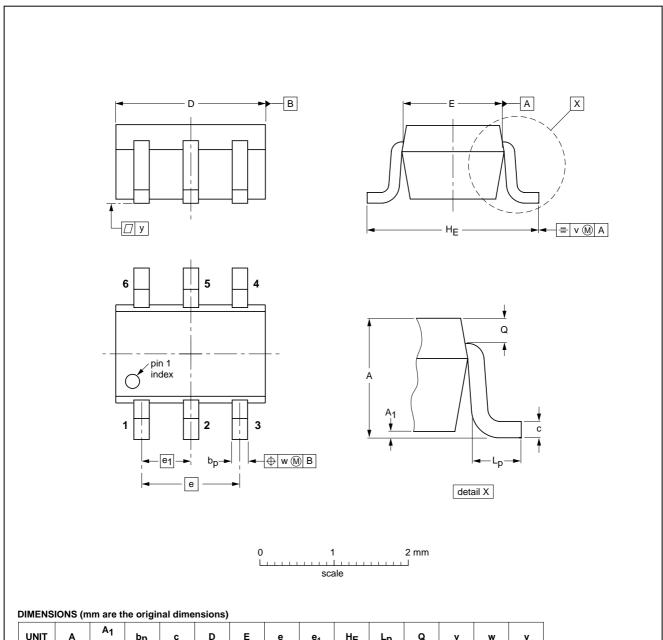
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NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

PEMD4; PUMD4

Plastic surface mounted package; 6 leads

SOT363



mm 1.1 0.8 0.1 0.30 0.25 0.20 1.35 1.15 1.3 0.65 2.2 0.45 0.25 0.15 0.2 0.2 0.1	UNIT	A	max	bp	С	D	E	е	e ₁	HE	Lp	Q	v	w	У
	mm		0.1		1			1.3	0.65		l		0.2	0.2	0.1

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE		
VERSION	IEC	C JEDEC EIAJ			PROJECTION	ISSUE DATE	
SOT363			SC-88			97-02-28	

NPN/PNP resistor-equipped transistors; R1 = 10 k Ω , R2 = open

PEMD4; PUMD4

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- 2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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NXP Semiconductors

Customer notification

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Contact information

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Printed in The Netherlands R75/02/pp8 Date of release: 2003 Oct 10 Document order number: 9397 750 11826



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